# **EcoSPARK<sup>®</sup> 2 Ignition IGBT**

# 300 mJ, 400 V, N-Channel Ignition IGBT

## Features

- SCIS Energy = 300 mJ at  $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- AEC-Q101 Qualified and PPAP Capable
- RoHS Compliant

## Applications

- Automotive Ignition Coil Driver Circuits
- Coil on Plug Application

#### **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ unless otherwise stated)

Symbol	Parameter	Value	Units
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage (I <sub>C</sub> = 1 mA)	400	V
BV <sub>ECS</sub>	Emitter to Collector Voltage – Reverse Battery Condition ( $I_C = 10 \text{ mA}$ )	28	V
E <sub>SCIS25</sub>	Self Clamping Inductive Switching Energy (Note 1)	300	mJ
E <sub>SCIS150</sub>	Self Clamping Inductive Switching Energy (Note 2)	170	mJ
I <sub>C25</sub>	Collector Current Continuous at VGE = 5.0 V, $T_{C}$ = 25°C	41	A
I <sub>C110</sub>	Collector Current Continuous at VGE = 5.0 V, T <sub>C</sub> = 110°C	25.6	A
V <sub>GEM</sub>	Gate to Emitter Voltage Continuous	±10	V
PD	Power Dissipation Total, $T_C = 25^{\circ}C$	150	W
	Power Dissipation Derating, $T_C > 25^{\circ}C$	1	W/°C
TJ	Operating Junction and Storage Temperature	–55 to 175	°C
T <sub>STG</sub>	Storage Junction Temperature Range	–55 to 175	°C
TL	T <sub>L</sub> Max. Lead Temperature for Soldering (Package Body for 10 s)		°C
Т <sub>РКG</sub>	T <sub>PKG</sub> Max. Lead Temperature for Soldering (Package Body for 10 s)		°C
ESD	HBM – Electrostatic Discharge Voltage at 100 pF, 1500 $\Omega$	4	kV
	CDM – Electrostatic Discharge Voltage at 1 $\Omega$	2	kV

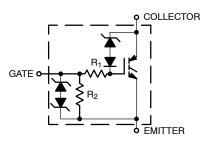
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Self clamped inductive Switching Energy (ESCIS25) of 300 mJ is based on the test conditions that is starting  $T_J = 25^{\circ}C$ , L = 3 mHy, ISCIS = 14.2 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.
- 2. Self Clamped inductive Switching Energy (ESCIS150) of 170 mJ is based on the test conditions that is starting  $T_J = 150^{\circ}$ C, L = 3mHy, ISCIS = 10.8 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.



# **ON Semiconductor®**

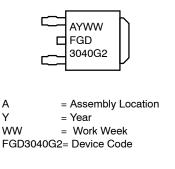
www.onsemi.com





DPAK (SINGLE GAUGE) CASE 369C

# MARKING DIAGRAM



# ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

#### THERMAL RESISTANCE RATINGS

Characteristic	Symbol	Мах	Units
Junction-to-Case – Steady State (Drain)		1	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Test Conditions		Min	Тур.	Max.	Units
OFF CHARA	ACTERISTICS	-					-
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage	$I_{CE} = 2 \text{ mA}, V_{GE} = 0 \text{ V},$ $R_{GE} = 1 \text{ k}\Omega, T_J = -40 \text{ to } 150^{\circ}\text{C}$		370	400	430	V
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$I_{CE}$ = 10 mA, $V_{GE}$ = 0 V, R <sub>GE</sub> = 0, T <sub>J</sub> = -40 to 150°C		390	420	450	V
BV <sub>ECS</sub>	Emitter to Collector Breakdown Voltage	$I_{CE}$ = -20 mA, $V_{GE}$ = 0 V, T <sub>J</sub> = 25°C		28	-	-	V
BV <sub>GES</sub>	Gate to Emitter Breakdown Voltage	$I_{GES} = \pm 2 \text{ mA}$		±12	±14	-	V
I <sub>CER</sub>	Collector to Emitter Leakage Current	V <sub>CE</sub> = 250 V	T <sub>J</sub> = 25°C	-	-	25	μΑ
		$R_{GE} = 1 \ k\Omega$	T <sub>J</sub> = 150°C	-	-	1	mA
I <sub>ECS</sub>	Emitter to Collector Leakage Current	V <sub>EC</sub> = 24 V	T <sub>J</sub> = 25°C	-	-	1	mA
			T <sub>J</sub> = 150°C	-	-	40	
R <sub>1</sub>	Series Gate Resistance			-	120	-	Ω
R <sub>2</sub>	Gate to Emitter Resistance			10K	-	30K	Ω
ON CHARAC	CTERISTICS (Note 5)	-					-
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE} = 6 \text{ A}, V_{GE} = 4 \text{ V}, T_{J} = 25^{\circ}\text{C}$		-	1.15	1.25	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE}$ = 10 A, $V_{GE}$ = 4.5 V, $T_{J}$ = 150°C		-	1.35	1.50	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE}$ = 15 A, $V_{GE}$ = 4.5 V, $T_{J}$ = 150°C		-	1.68	1.85	V
E <sub>SCIS</sub>	Self Clamped Inductive Switching	L = 3.0 mHy, RG = 1 KΩ, VGE = 5 V, (Note 1)		-	-	300	mJ
DYNAMIC C	HARACTERISTICS						-
Q <sub>G(ON)</sub>	Gate Charge	$I_{CE}$ = 10 A, $V_{CE}$ = 12 V, $V_{GE}$ = 5 V		_	21	-	nC
V <sub>GE(TH)</sub>	Gate to Emitter Threshold Voltage	I <sub>CE</sub> = 1 mA V <sub>CE</sub> = V <sub>GE</sub>	T <sub>J</sub> = 25°C	1.3	1.7	2.2	V
			T <sub>J</sub> = 150°C	0.75	1.2	1.8	1
$V_{GEP}$	Gate to Emitter Plateau Voltage	V <sub>CE</sub> = 12 V, I <sub>CE</sub> = 10 A		-	2.8	-	V
SWITCHING	CHARACTERISTICS						
td <sub>(ON)R</sub>	Current Turn-On Delay Time-Resistive	$V_{CE} = 14 \text{ V}, \text{ R}_{L} = 1 \Omega, \text{ V}_{GE} = 5 \text{ V},$ $\text{R}_{G} = 1 \text{ K}\Omega, \text{ T}_{J} = 25^{\circ}\text{C}$		-	0.9	4	μs
t <sub>rR</sub>	Current Rise Time-Resistive			-	1.9	7	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

 $\begin{array}{l} V_{CE} = 300 \; V, \, L = 1 \; mH, \, V_{GE} = 5 \; V, \\ R_G = 1 \; \mathrm{K}\Omega, \, I_{CE} = 6.5 \; A, \, T_J = 25^\circ C \end{array}$ 

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4.8

2.0

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#### PACKAGE MARKING AND DEVICE ORDERING INFORMATION

Current Turn-Off Delay Time-Inductive

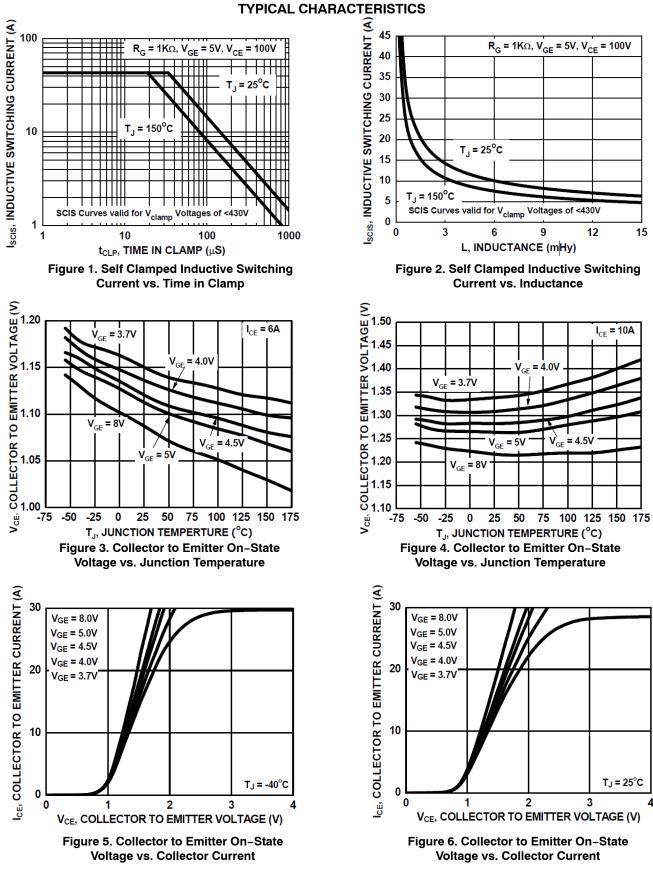
Current Fall Time-Inductive

td<sub>(OFF)L</sub>

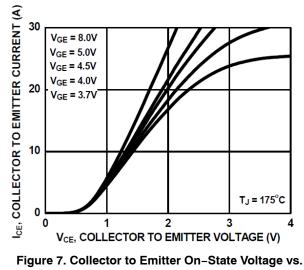
t<sub>fL</sub>

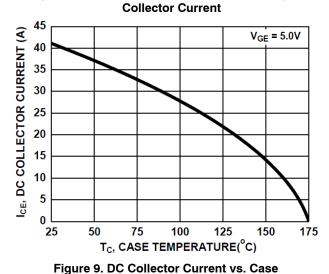
Device Marking	Device	Package	Reel Diameter	Tape Width	Qty <sup>†</sup>
FGD3040G2	FGD3040G2-F085V	DPAK (Pb-Free)	330 mm	16 mm	2500

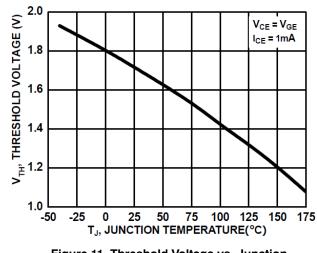
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



#### TYPICAL CHARACTERISTICS (continued)

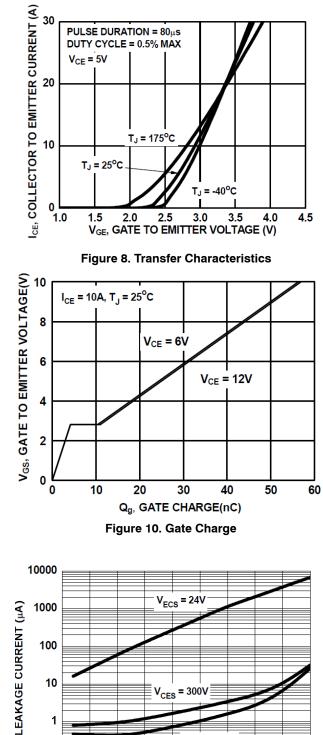


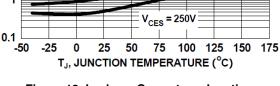


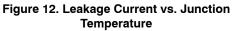


Temperature

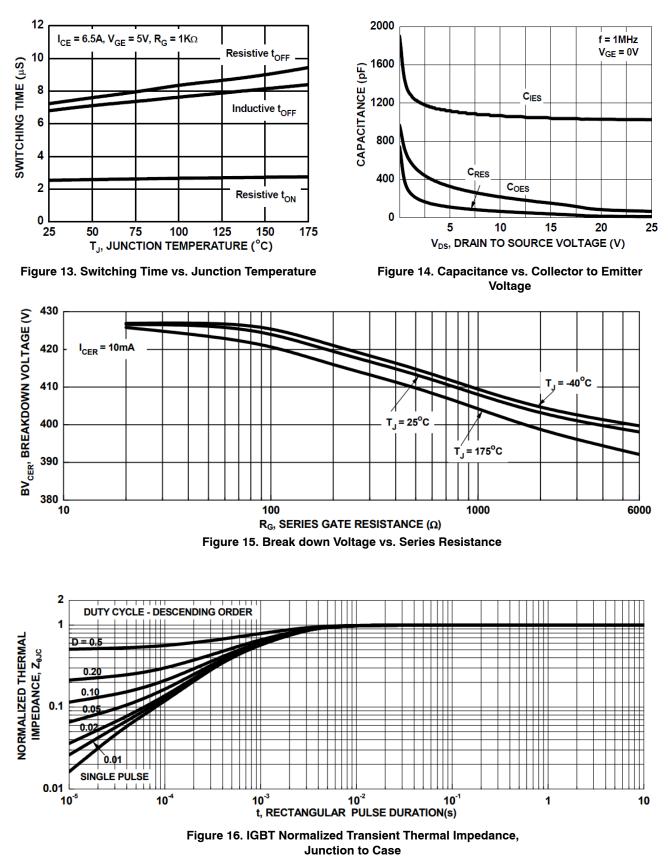








## TYPICAL CHARACTERISTICS (continued)



# TYPICAL CHARACTERISTICS (continued)

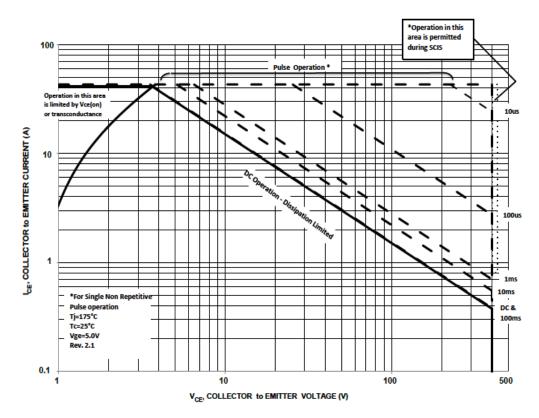
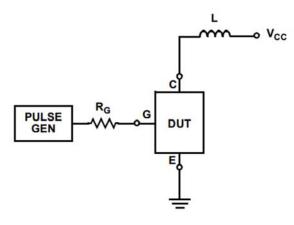


Figure 17. Forward Safe Operating Area

# **TEST CIRCUIT AND WAVEFORMS**





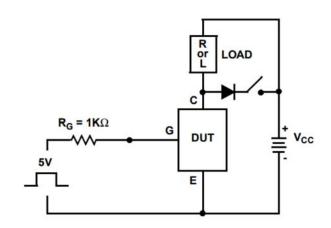


Figure 19.  $t_{\text{ON}}$  and  $t_{\text{OFF}}$  Switching Test Circuit

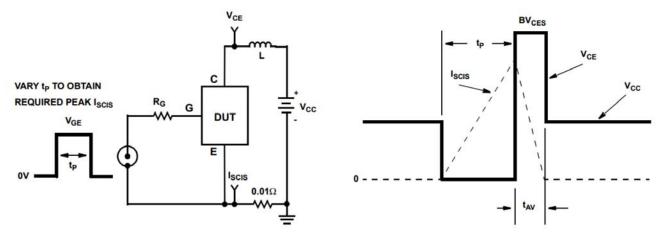


Figure 20. Energy Test Circuit



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